

# **2022 IEEE 26th Workshop on Signal and Power Integrity (SPI 2022)**

**Siegen, Germany  
22 – 25 May 2022**



**IEEE Catalog Number: CFP22SPI-POD  
ISBN: 978-1-6654-8626-2**

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IEEE Catalog Number:	CFP22SPI-POD
ISBN (Print-On-Demand):	978-1-6654-8626-2
ISBN (Online):	978-1-6654-8625-5

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# Monday, May 23, 2022

## Technical Sessions

### Monday, May 23 - Technical Sessions

#### ① Measurement and Characterization / Power Distribution Networks

Chair: Mihai Telescu, Université de Bretagne Occidentale, Brest (FRA)

#### **13:40 EMC Issues and Signal Integrity Analysis of Neutron Diagnostics for Nuclear Fusion Machines...1**

A. Maffucci, D. Capriglione, F. Pompili, B. Esposito, D. Marocco, M. Passeri and M. Riva

#### **14:00 Accurate Characterization of Radiation from Interconnects on Interposer at mmWave Frequencies...5**

M. Huynen, D. Bosman, A. Moerman and D. Vande Ginste

#### **14:20 Comparison of coplanar waveguide models at millimetre wave frequencies...9**

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A. Carlucci, A. Zanco, R. Trincherro and S. Grivet-Talocia

Best Student Paper Award



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### Tuesday, May 24 - Technical Sessions

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Chair: Stefano Grivet-Talocia, Politecnico di Torino, Torino (ITA)

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H. Zhou , W. Zhang

Best Paper Award



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Chair: Antonio Maffucci, University of Cassino and Southern Lazio, Cassino (ITA)

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L. Bai

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### Wednesday, May 25 - Technical Sessions

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